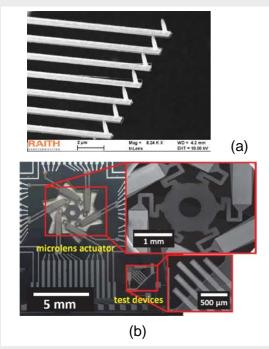


Design, fabrication, and measurement of nano and micro scale systems with mechanical, electrical, and/or optical functionalities on a silicon substrate or integrated circuits (CMOS) to enable development of novel and advanced sensors and actuators.



(a) Sharp nanotips on nano-cantilever(b) Micro-actuator released on silicon chip

More information

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Nano/Micro optical, electrical, and mechanical systems on silicon chip/Integrated circuits

MEMS and NEMS Group/Electrical Engineer and Telecommunication/Faculty of Engineering

Competitive Advantage

- A number of technologies, which are not available elsewhere, are developed for **the first time**. The technologies are being protected by patents or IP is being filed. The technologies include
- High aspect ratio sharp nanotips: CMOS compatible and integration with nano-scale devices at unprecedented density, which is not possible with any other technology anywhere else.
- PZT microlens micro-actuators: Record breaking large displacement and resonance frequency, and small footprint micro-lens piezoelectric actuator for micro-optics application are developed.
- Low thermal budget polysilicon films: Thick and low stress silicon film with low thermal budget suitable for MEMS formation on top of CMOS is possible only with this technology. Record breaking high gauge factor piezo-resistive polysilicon at low thermal budget is obtained recently from these films.

Recent research projects

- High speed parallel AFM on a single chip aims at developing the smallest and fastest AFM system.
- Piezoelectric micro-actuators aims at enhancing the performances (autofocus and optical zooming) of micro-optic devices through advanced microactuators.
- Low thermal budget polysilicon films- aims at enabling electrical, optical and mechanical systems on top of CMOS process.

Successful applications

• Research publications around the technologies are available demonstrating the capability of the technology. They can be provided upon request.

Facilities and infrastructure

- Access to the state-of-the art advanced semiconductor manufacturing tools in ANFF at UNSW and other nodes around Australia.
- Access to the state-of-the art Mark Wainwright analytical centre for process monitoring, diagnostic and film characterisation.
- MEMS measurement lab equipped with Polytech MSA-500 with the capability of measuring dynamics of nano/micro structures with sub-nm displacement resolution.
- Silicon photonics characterization optical bench set-up with automatic nanopositioners, deterministic polarization controller, and 7.5GHz spectrum

Our experts

- Dr. Aron Michael
- Prof Chee Yee Kwok

